Please replace the Abstract with the following amended Abstract:

Abstract of the Disclosure

Semiconductor component comprising an integrated latticed capacitance structure.

An insulating layer which is produced on a semiconductor substrate has a capacitance structure (K) produced in it. The capacitance structure (K) has at least one first substructure (T1a) which has a metal latticed region (G1a to G1c) and electrically conductive regions (P1a to P1c) which are arranged in the cutouts in the metal latticed region (G1a to G1c), the metal latticed region (G1a to G1c) being are electrically connected to a first connecting line, and the electrically conductive regions (P1a to P1c) being are electrically connected to a second connecting line.

A clean version of the amended Abstract is provided in the attached sheet.